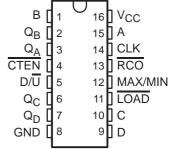
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- Single Down/Up Count-Control Line
- **Look-Ahead Circuitry Enhances Speed of Cascaded Counters**
- **Fully Synchronous in Count Modes**
- **Asynchronously Presettable With Load** Control
- **Package Options Include Plastic** Small-Outline (D) and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

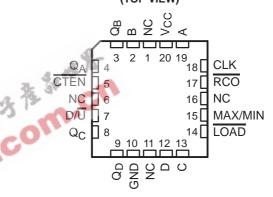
description

The 'HC191 are 4-bit synchronous, reversible, up/down binary counters. Synchronous counting operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (rippleclock) counters.

The outputs of the four flip-flops are triggered on a low-to-high-level transition of the clock (CLK) input if the count-enable (CTEN) input is low. A high at CTEN inhibits counting. The direction of the count is determined by the level of the down/up (D/\overline{U}) input. When D/\overline{U} is low, the counter counts up, and when D/U is high, it counts down. SN54HC191 . . . J OR W PACKAGE SN74HC191...D OR N PACKAGE (TOP VIEW) 16 V_{CC} В Q_B 15 A 14 CLK



SN54HC191...FK PACKAGE (TOP VIEW)



NC - No internal connection

These counters feature a fully independent clock circuit. Change at the control (CTEN and D/U) inputs that modifies the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter is dictated solely by the condition meeting the stable setup and hold times.

These counters are fully programmable; that is, each of the outputs can be preset to either level by placing a low on the load (LOAD) input and entering the desired data at the data inputs. The output changes to agree with the data inputs independently of the level of CLK. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

Two outputs are available to perform the cascading function: ripple clock (RCO) and maximum/minimum (MAX/MIN) count. MAX/MIN produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock while the count is zero (all outputs low) counting down, or maximum (9 or 15) counting up. RCO produces a low-level output pulse under those same conditions, but only while CLK is low. The counters can be easily cascaded by feeding RCO to CTEN of the succeeding counter if parallel clocking is used, or to CLK if parallel enabling is used. MAX/MIN can be used to accomplish look ahead for high-speed operation.

The SN54HC191 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74HC191 is characterized for operation from -40°C to 85°C.

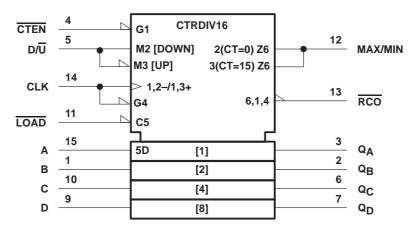


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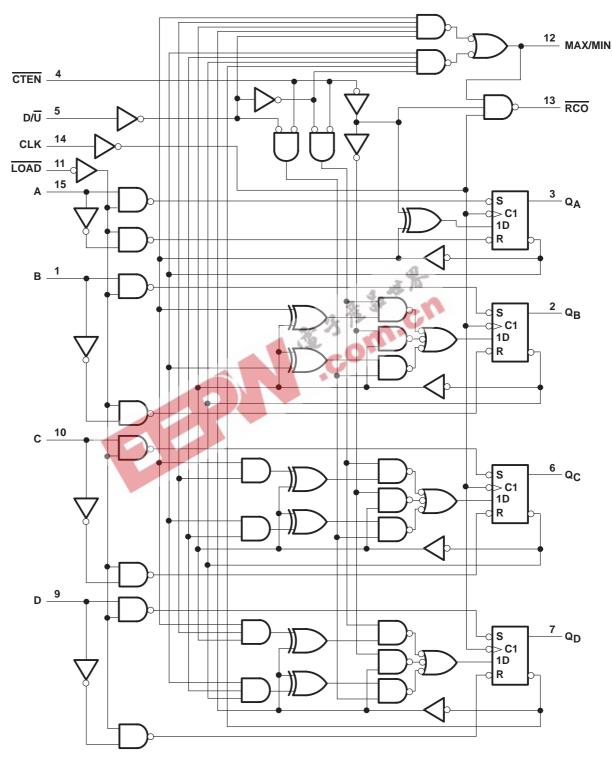
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, and W packages.



logic diagram (positive logic)



Pin numbers shown are for the D, J, N, and W packages.

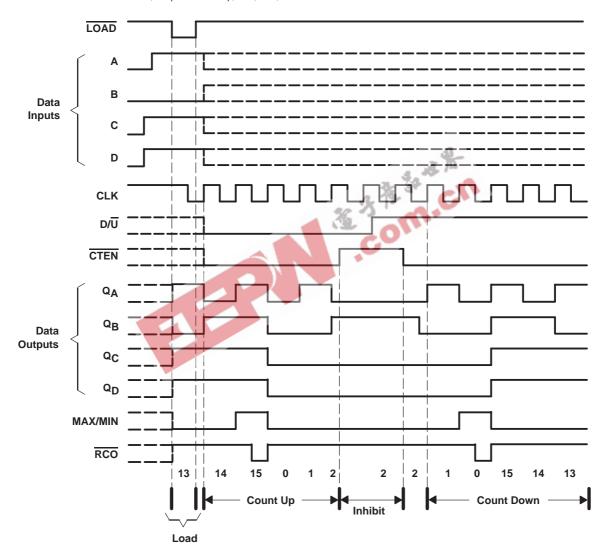


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typical load, count, and inhibit sequence

The following sequence is illustrated below:

- 1. Load (preset) to binary 13
- 2. Count up to 14, 15 (maximum), 0, 1, and 2
- 3. Inhibit
- 4. Count down to 1, 0 (minimum), 15, 14, and 13





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absolute maximum ratings over operating free-air temperature range[†]

Supply voltage range, V _{CC}	0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ _{JA} (see Note 2): D package	113°C/W
N package	78°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions

			SN54HC1	91	SN74HC191			UNIT
			MIN NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2 5	6	2	5	6	V
		V _{CC} = 2 V	1.5		1.5			
VIH	High-level input voltage	V _{CC} = 4.5 V	3.15		3.15			V
		VCC = 6 V	4.2		4.2			
	Low-level input voltage	$V_{CC} = 2 V$	0	0.5	0		0.5	V
VIL		V _{CC} = 4.5 V	0	1.35	0		1.35	
		$V_{CC} = 6 \text{ V}$	0	1.8	0		1.8	
٧ _I	Input voltage		0	Vcc	0		VCC	V
۷o	Output voltage		0	VCC	0		VCC	V
		V _{CC} = 2 V	0	1000	0		1000	
t _t ‡	Input transition (rise and fall) time	V _{CC} = 4.5 V	0	500	0		500	ns
		V _{CC} = 6 V	0	400	0		400	
TA	Operating free-air temperature		- 55	125	-40		85	°C

[‡] If this device is used in the threshold region (from V_{IL}max = 0.5 V to V_{IH}min = 1.5 V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at t_t = 1000 ns and V_{CC} = 2 V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.



^{2.} The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Voc	T _A = 25°C			SN54HC191		91 SN74HC191		UNIT
PARAMETER			VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Vон			2 V	1.9	1.998		1.9		1.9		
		$I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		4.4		
	$V_I = V_{IH}$ or V_{IL}		6 V	5.9	5.999		5.9		5.9		V
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
			2 V		0.002	0.1		0.1		0.1	
		I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1	
VOL	VI = VIH or VIL		6 V		0.001	0.1		0.1		0.1	V
		I _{OL} = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
		I _{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
Ι _Ι	V _I = V _{CC} or 0		6 V		±0.1	±100		±1000		±1000	nA
ICC	$V_I = V_{CC}$ or 0,	$V_I = V_{CC} \text{ or } 0, I_O = 0$				8		160		80	μΑ
Ci			2 V to 6 V		3	10	-	10		10	рF
				36	3 3 60	W.	cn				



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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			V	T _A = 25°C		SN54F	IC191	SN74H	C191	UNIT
			VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNII
			2 V	0	4.2	0	2.8	0	3.3	
fclock	Clock frequency		4.5 V	0	21	0	14	0	17	MHz
			6 V	0	24	0	16	0	19	
			2 V	120		180		150		
		LOAD low	4.5 V	24		36		30		
١.	Pulse duration		6 V	21		31		26		ns
t _W	ruise duration		2 V	120		180		150		115
		CLK high or low	4.5 V	24		36		30		
			6 V	21		31		26		
			2 V	150		230		188		
		Data before LOAD↑	4.5 V	30		46		38		
			6 V	25		38		32		ns
		CTEN before CLK↑	2 V	205	- 15	306		255		
			4.5 V	41		61		51		
١.	Setup time		6 V	35	C	53		44		
t _{su}	Setup time	1	2 V	205		306		255		
		D/U before CLK↑	4.5 V	41		61		51		
			6 V	35		53		44		
			2 V	150		225		190		
		LOAD inactive before CLK↑	4.5 V	30		45		38		
			6 V	25		38		32		
			2 V	5		5		5		
		Data after LOAD↑	4.5 V	5		5		5	5	
			6 V	5		5		5		
			2 V	5		5		5		
th	Hold time	CTEN after CLK↑	4.5 V	5		5		5		ns
			6 V	5		5		5		
			2 V	5		5		5		
		D/ U after CLK↑	4.5 V	5		5		5		
			6 V	5		5		5		

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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

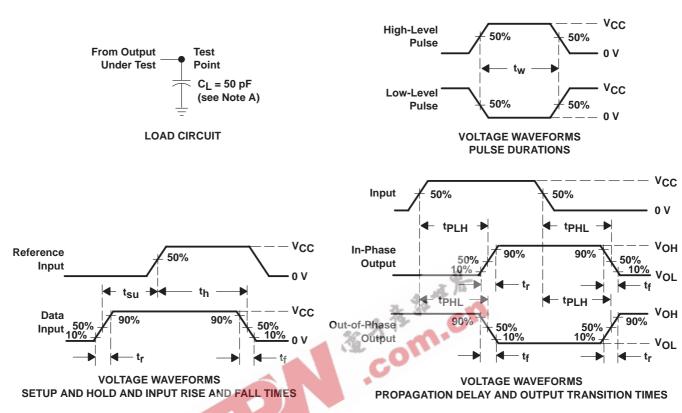
PARAMETER	FROM	то	V	T,	Δ = 25°C	;	SN54H	IC191	SN74H	C191	UNIT		
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII		
			2 V	4.2	8		2.8		3.3				
f _{max}			4.5 V	21	42		14		17		MHz		
			6 V	24	48		16		19				
			2 V		130	264		396		330			
	LOAD	Any Q	4.5 V		40	53		79		66			
			6 V		33	45		67		56			
		0. 0- 0-	2 V		135	240		360		300			
	A, B, C, or D	Q_A , Q_B , Q_C , or Q_D	4.5 V		36	48		72		60			
		3. L D	6 V		30	41		61		51			
			2 V		58	120		180		150			
		RCO	4.5 V		17	24		36		30			
			6 V		14	21		31		26			
	MAX	Any Q MAX/MIN	2 V		107	192		288		240 48 41			
			4.5 V		31	38	-	58					
			6 V		26	32		49			ns		
^t pd			MAX/MIN	MAX/MIN	2 V		123	252		378		315	113
					4.5 V	130	39	50		76		63	
			6 V		32	43		65		54			
			2 V		102	228		342		285			
		RCO	4.5 V		29	46		68		57			
			6 V		24	38		59		49			
			2 V		86	192		288		240			
		MAX/MIN	4.5 V		24	38		58		48			
			6 V		20	32		49		41			
			2 V		50	132		198		165			
	CTEN	RCO	4.5 V		15	26		40		33			
			6 V		13	23		34		28			
			2 V		38	75		110		95			
t _t		Any	4.5 V		8	15		22		19	ns		
			6 V		6	13		19		16			

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	50	pF

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50~\Omega$, $t_r = 6$ ns, $t_f = 6$ ns. C. For clock inputs, t_{max} is measured when the input duty cycle is 50%.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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